LP265,LP365

LP265 LP365 Micropower Programmable Quad Comparator



Literature Number: SNOSBC5A



LP265/LP365 Micropower Programmable Quad Comparator

General Description

Typical Connection

The LP365 consists of four independent voltage comparators. The comparators can be programmed, four at the same time, for various supply currents, input currents, response times and output current drives. This is accomplished by connecting a single resistor between the V_{CC} and I_{SET} pins.

These comparators can be operated from split power supplies or from a single power supply over a wide range of voltages. The input can sense signals at ground level even with single supply operation. The unique output NPN transistor stages are uncommitted to either power supply. They can be connected directly to various logic system supplies so that they are highly flexible to interface with various logic families.

Application areas include battery power circuits, threshold detectors, zero crossing detectors, simple serial A/D converters, VCO, multivibrators, voltage converters, power sequencers, and high performance V/F converters, and RTD linearization.

Features

- Single programming resistor to tailor power consumption, input current, speed and output current drive capability
- \blacksquare Wide single supply voltage range or dual supplies (4 V_{DC} to 36 V_{DC} or ± 2.0 V_{DC} to ± 18 V_{DC})
- \blacksquare Low supply current drain (10 $\mu A)$ and low power consumption (10 $\mu W/comparator)$ @ I_{SET} = 0.5 μA
- V_{CC} = 5_{VDC} ■ Uncommitted output stage—selectable output levels
- Output directly compatible with DTL, TTL, CMOS, MOS
- or other special logic families
- Input common-mode range includes ground
- Differential input voltage equal to the power supply voltage

Connection Diagram



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| Absolute Maximum Military/Aerospace speci lease contact the Natio ffice/Distributors for availa upply Voltage | n Ratings fied devices are required, nal Semiconductor Sales ability and specifications. | Power Dissipation (Note 3) T _j Max θ _{jA} Lead Temp. | M Package 500 mW 115℃ 115℃/W | N Pa 500 11 90° |
|---|---|---|--|---------------------------------|
| Differential Input Voltage | $\pm 36 V_{DC}$ $\pm 36 V_{DC}$ | (Soldering—10 sec.) (Vapor Phase—60 sec.) | 215°C | 26 |
| Dutput Short Circuit to V _E (Not | e 2) Continuous | (Infrared—15 sec.) Operating Temp. Range LP365: | 220°C 0°C ≤ | $T_A \leq \cdot$ |
| / _{OUT} with Respect to V _E ESD Tolerance (Note 10) | V _E −7V≤V _{OUT} ≤V _E +36V 2000V | Storage Temp. Range | $-40^{\circ}C \le T$ | $A \leq +$ |

Electrical Characteristics (Note 4) Low power V_S=5V, I_{SET}=10 μ A

| | | | LP365A | | | LP365 | | | |
|-------------------|-----------------------------------|---|--------|-----------------------------|-----------------------------|---------|-----------------------------|-----------------------------|------------------|
| Symbol | Parameter | Conditions | Тур | Tested Limit (Note 5) | Design Limit (Note 6) | Тур | Tested Limit (Note 5) | Design Limit (Note 6) | Units (Limit) |
| V _{OS} | Input Offset Voltage | V _{CM} =OV, R _S =100 | 1 | 3 | 6 | 3 | 6 | 9 | mV (Max) |
| l _{OS} | Input Offset Current | V _{CM} =0V LP265 | 2 | 20 | 50 | 4 | 25 | 75 | nA (Max) |
| IB | Input Bias | V _{CM} =0V | 10 | 50 | 125 | 4 15 | 25 75 | 150 200 | nA |
| Ci | Current | LP265 | | | | 15 | 75 | 300 | (Max) |
| A _{VOL} | Large Signal Voltage Gain | R _L =100k | 500 | 50 | 50 | 300 | 25 | 25 | V/mV (Min) |
| V _{CM} | Input Common- Mode Voltage | | | 0 | 0 | | 0 | 0 | V (Max) |
| Range | Range | | | 3 | 3 | | 3 | 3 | V (Min) |
| CMRR | Common-Mode Rejection Ratio | $0 \le V_{CM} \le 3V$ | 85 | 75 | 70 | 80 | 75 | 70 | dB (Min) |
| PSRR | Supply Voltage Rejection Ratio | $\pm 2.5V \le V_S$ $\le \pm 3.5V$ | 75 | 65 | 65 | 70 | 65 | 65 | dB (Min) |
| I _S | Supply Current | All Inputs = 0V, $R_L = \infty$ | 215 | 250 | 300 | 225 | 275 | 300 | μA (Max) |
| V _{OH} | Output Voltage High | $V_{C} = 5V,$ $V_{E} = 0V,$ $R_{L} = 100k$ | | 4.9 | 4.5 | | 4.9 | 4.5 | V (Min) |
| V _{OL} | Output Voltage Low | V _E =0V | | 0.4 | 0.4 | | 0.4 | 0.4 | V (Max) |
| I _{SINK} | Output Sink Current | V _E =0V, V _O =0.4V | 2.4 | 1.2 | 0.6 | 2.0 | 0.8 | 0.4 | mA (Min) |
| I _{LEAK} | Output Leakage Current | $V_{C} = 5V,$ $V_{E} = 0V$ | 2 | 50 | 5000 | 2 | 100 | 5000 | nA (Max) |
| t _R | Response Time | $V_{CC} = 5V,$ $V_{E} = 0V,$ $R_{L} = 5k,$ $C_{L} = 10 \text{ pF}$ (Note 7) | 4 | | | 4 | | | μs |

| | | Conditions | LP365A | | | LP365 | | | |
|--|-----------------------------------|---|--------|-----------------------------|-----------------------------|------------|-----------------------------|-----------------------------|------------------|
| Symbol | Parameter | | Тур | Tested Limit (Note 5) | Design Limit (Note 6) | Тур | Tested Limit (Note 5) | Design Limit (Note 6) | Units (Limit) |
| V _{OS} | Input Offset Voltage | V _{CM} =0V, R _S =100 | 1 | 3 | 6 | 3 | 6 | 9 | mV (Max) |
| I _{OS} | Input Offset Current | V _{CM} =0V LP265 | 5 | 50 | 100 | 10 10 | 90 90 | 200 500 | nA (Max) |
| IB | Input Bias Current | V _{CM} =0V LP265 | 60 | 200 | 500 | 80 80 | 300 300 | 500 800 | nA (Max) |
| A _{VOL} | Large Signal Voltage Gain | R _L =15k | 500 | 100 | 100 | 500 | 100 | 100 | V/mV (Min) |
| V _{CM} Input Common- Mode Voltage Range | | | - 15 | - 15 | | - 15 | - 15 | V (Max) | |
| | | | 13 | 13 | | 13 | 13 | V (Min) | |
| CMRR | Common-Mode Rejection Ratio | −15V≤V _{CM} ≤13V | 85 | 75 | 70 | 80 | 75 | 70 | dB (Min) |
| PSRR | Supply Voltage Rejection Ratio | $\pm 10V \le V_S$ $\le \pm 15V$ | 80 | 70 | 70 | 75 | 70 | 70 | dB (Min) |
| I _S | Supply Current | All Inputs = 0V, $R_L = \infty$, LP265 | 2.6 | 3 | 3.3 | 2.8 2.8 | 3.5 3.5 | 3.7 4.3 | mA (Max) |
| V _{OH} | Output Voltage High | $V_{C}=5V,$ $V_{E}=0V,$ $R_{L}=100k$ | | 4.9 | 4.5 | | 4.9 | 4.5 | V (Min) |
| V _{OL} | Output Voltage Low | V _E =0V | | 0.4 | 0.4 | | 0.4 | 0.4 | V (Max) |
| I _{SINK} | Output Sink Current | V _E =0V, V _O =0.4V | 10 | 8 | 5.5 | 7.5 | 6 | 4 | mA (Min) |
| I _{LEAK} | Output Leakage Current | V _C =15V, V _E =-15V | 5 | 50 | 5000 | 5 | 50 | 5000 | nA (Max) |
| t _R | Response Time | $V_{CC} = 5V,$ $V_{E} = 0V,$ $R_{L} = 5k,$ $C_{L} = 10 \text{ pF}$ (Note 7) | 1.0 | | | 1.0 | | | μs |

Note 1: The input voltage is not allowed to go 0.3V above V⁺ or -0.3V below V⁻ as this will turn on a parasitic transistor causing large currents to flow through the device.

Note 2: Short circuits from the output to V⁺ may cause excessive heating and eventual destruction. The current in the output leads and the V_E lead should not be allowed to exceed 30 mA. The output should not be shorted to V⁻ if V_E \leq (V⁻) + 7V.

Note 3: For operating at elevated temperatures, these devices must be derated based on a thermal resistance of θ_{jA} and T_j max. $T_j = T_A + \theta_{jA} P_D$.

Note 4: Boldface numbers apply at temperature extremes. All other numbers apply at $T_A = T_j = 25^{\circ}$ C, $V^+ = 5V$, $V^- = 0V$, $I_{SET} = 10 \ \mu$ A, $R_L = 100$ k, and $V_C = 5V$ as shown in the Typical Connection diagram.

Note 5: Guaranteed and 100% production tested.

Note 6: Guaranteed (but not 100% production tested) over the operating temperature and supply voltage ranges. These limits are not used to calculate out-going quality levels.

Note 7: The response time specified is for a 100 mV input step with 5 mV overdrive.

Note 8: Boldface numbers apply at temperature extremes. All other numbers apply at $T_A = T_j = 25^{\circ}$ C. $V^+ = +15$ V, $V^- = -15$ V, $I_{SET} = 100 \ \mu$ A, $R_L = 100$ k, and $V_C = 5$ V as shown in the Typical Connection diagram.

Note 9: See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Note 10: Human body model, 1.5 k Ω in series with 100 pF.















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